

	Note	Min.	Max.	Unit
Storage temperature	Recommended storage condition is < 40°C and < 90% RH (relative humidity)	-40	+125	°C
Reflow soldering temperature	Reflow cycle time is 30 seconds with 3 maximum reflow cycles.		260	°C
Moisture Sensitivity Level (MSL)			1	
ESD Human Body Model (HBM)			3	kV
ESD Charged Device Model (CDM)			250	V

Table 97: Environmental CSP package types

	Min.	Max.	Unit
Endurance	10,000		Write/ rewrite cycles
Retention at 85°C	10		y
Retention at 105°C	2		y

Table 98: RRAM memory

